



THE INNOVATOR

WINTER EDITION

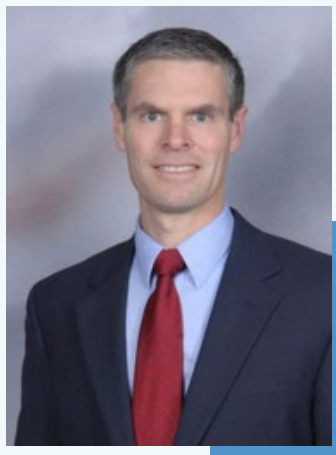
“PUSHING BOUNDARIES & INNOVATION”

VOLUME 6 | ISSUE 14

KOCH'S CORNER

From leading the Joint Defense Manufacturing Technology Panel (JDMTP) to our first hackathon, DLA R&D is poised to push the boundaries of innovation in new and exciting ways in 2024!

Team R&D ended 2023 on a high note with a large contingent attending the annual Defense Manufacturing Conference in Nashville, Tennessee. DLA was highly visible throughout the conference - receiving awards and recognition, participating in panels, and leading technical, poster, and outreach sessions. My official appointment as the new JDMTP chair was a personal highlight.



As DLA's first JDMTP chair, I plan to capitalize on joint service projects wherever possible, increase engagement within the Manufacturing Technology (ManTech) community and Defense Manufacturing Innovation Institutes (MIIs), provide solid oversight of key technology subpanels, and pursue joint ManTech opportunities to accelerate adoption of critical defense technologies that enhance value to the DoD industrial base, support supply chain resiliency, and build workforce capabilities. This is important for R&D, and DLA as a whole, as an increasingly valued partner across the DoD enterprise. I am grateful for the opportunity to serve in this role.

Looking ahead, R&D will hit the road again this spring for our annual MSC visits. This year's theme is "Plans, Projects, Priorities." We look forward to hearing each of the MSCs' P3s!

Lastly, our entire team is excited about our first hackathon this spring, focused on integrating GenAI, to enhance our warfighter sustainment mission.

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DLA R&D MISSION

Develop and deliver new capabilities through applied technologies and innovative solutions to enhance warfighter sustainment

DLA R&D VISION

Premier Innovation for Global Warfighter Mission Readiness



FEBRUARY 6-9

INNOVATION NAVIGATORS COURSE

FEBRUARY 19 PRESIDENT'S DAY

FEBRUARY 20

R&D QUARTERLY EOPC UPDATES

MARCH 1-31

MSC VISITS

APRIL - TBD

GENAI HACKATHON

JOINT DEFENSE MANUFACTURING TECHNOLOGY PANEL (JDMTP) 101

- Manages the identification and integration of joint ManTech requirements, projects, and efforts throughout the Department of Defense (DoD).
- Coordinates with technical subpanels and working groups to oversee and facilitate collaboration.
- Executes and advocates for the realization of the DoD's shared ManTech objectives.

DoD Manufacturing Technology Program



- JDMTP Chair – Mr. David Koch, DLA
- DLA Principal – Mr. David Koch
- DLA Action Officer – Ms. Martina Johnson
- DLA Support Staff – Mr. John Christensen and Ms. Lauren Faal



RPA MODERNIZES FINANCE

The J68 Finance Team is increasing its use of Robotic Process Automation (RPA) in 2024. Partnering with J8 and J6 RPA Team, they plan to enhance existing RPA by incorporating additional system interfaces for WAWF, IPAC, EDA, and MOCASS. These changes aim to save 10-15 minutes per transaction, resulting in over 300 annual manhours. The time saved will be used for more in-depth analysis with DFAS and other partners, addressing payment issues and improving J68's ability to meet OSD execution benchmarks. The team aspires to implement the updated RPA across the Enterprise, enhancing finance efficiencies and contributing to overall organizational success.



CONTRACTING x NATIONAL SECURITY

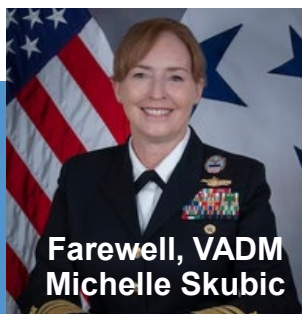
DLA R&D is intensifying efforts to safeguard U.S. technological competitiveness against global threats. Under the Small Business Innovative Research (SBIR) and Small Business Technology Transfer (STTR) Extension Act of 2022, the Due Diligence program has been introduced. This program includes expanded reporting requirements, award restrictions, and provisions addressing national security risks, especially concerning affiliations with China, Russia, North Korea, and Iran. Initially implemented by SBIR and STTR R&D programs, the Due Diligence program is now being extended to all fourteen Logistics R&D and ManTech programs in FY24. The objective is to enhance security measures and protect DoD and U.S. interests on a global scale.

WELCOME AND BID FAREWELLS



**Welcome, DLA's Director
LTG Mark Simerly**

DLA R&D is excited about exploring new frontiers and driving innovation alongside our new director.



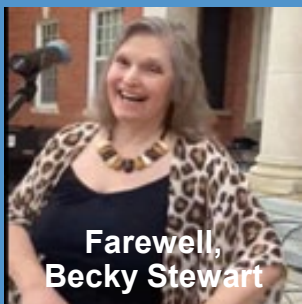
**Farewell, VADM
Michelle Skubic**

DLA appreciates your service and your contribution to the growth of DLA R&D.



**Welcome,
John Christensen**

Welcome aboard the DLA Team.



**Farewell,
Becky Stewart**

We thank you for 25 years of JDMTP service.

DMC HIGHLIGHTS



The DMC 2023 in Nashville showcased DLA'S significant role in supporting the joint force, with over 1,500 attendees.

Matt Hutchens, the program manager of R&D's Battery Network, among others received the Defense Manufacturing Technology Achievement Award.



DLA's 17 dynamic speakers and 7 innovative sessions shared our commitment to innovation and partnership.



**TAKING THE
PENTAGON
TO THE PEOPLE**



#DYK: Minority Serving Institutions (MSIs) are universities and colleges that enroll a significant percentage of students from minority groups.

- DLA Information Operations (J6) actively participates in the TTPTTP program, introducing Minority-Serving Institutions (MSIs) to DoD's STEM, PACE programs, and employment opportunities.
- J6 takes pride in promoting its academic research and employment opportunities as part of the TTPTTP program. The engagement involves comprehensive briefings during college visits, where J6 leaders connect with academic leadership, participate in Presidential Roundtables, and directly engage with students and faculties at career fairs and events.
- An upcoming event at New Mexico State University, led by J6 leaders including DLA CIO Adarryl Roberts, highlights their commitment to bridging the gap between DLA and minority-serving institutions, fostering collaboration, and exploring opportunities.

#STAYCONNECTEDWITHR&D

